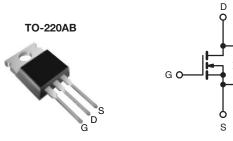


**Vishay Siliconix** 

### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	500				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 3.0				
Q <sub>g</sub> (Max.) (nC)	24				
Q <sub>gs</sub> (nC)	3.3				
Q <sub>gd</sub> (nC)	13				
Configuration	Single				



N-Channel MOSFET

#### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF820PbF
	SiHF820-E3
SnPb	IRF820
	SiHF820

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	500	v	
Gate-Source Voltage			V <sub>GS</sub>	± 20	v	
Continuous Drain Current	V =======	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		2.5		
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 100 ^{\circ}{\rm C}$	I <sub>D</sub>	1.6	А	
Pulsed Drain Current <sup>a</sup>	·		I <sub>DM</sub>	8.0		
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	210	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	2.5	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	5.0	mJ	
Maximum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			PD	50	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	3.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	℃	
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>	C	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N·m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 60 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 2.5$  A (see fig. 12).

c.  $I_{SD} \leq 2.5$  A, dI/dt  $\leq 50$  A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	2.5		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	500	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.59	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		= 500 V, V <sub>GS</sub> = 0 V /, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	25 250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_{\rm D} = 1.5  {\rm A}^{\rm b}$	-	-	3.0	Ω
Forward Transconductance	g <sub>fs</sub>		= 50 V, I <sub>D</sub> = 1.5 A	1.5	-	-	S
Dynamic						•	1
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	360	-	
Output Capacitance	Coss		$V_{DS} = 25 V,$	-	92	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	37	-	
Total Gate Charge	Qg				-	24	1
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 2.1 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and $13^{\text{b}}$	-	-	3.3	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	-	13	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 250 V, I <sub>D</sub> = 2.1 A, R <sub>g</sub> = 18 Ω, R <sub>D</sub> = 100 Ω, see fig. 10 <sup>b</sup>		-	8.0	-	
Rise Time	t <sub>r</sub>			-	8.6	-	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	33	-	
Fall Time	t <sub>f</sub>				16	-	
Internal Drain Inductance	L <sub>D</sub>	6 mm (0.25")	Between lead, 6 mm (0.25") from package and center of die contact		4.5	-	
Internal Source Inductance	L <sub>S</sub>				7.5	-	- nH
Drain-Source Body Diode Characteristic	s					•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the		-	-	2.5	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	p - n junction diode		-	-	8.0	A
Body Diode Voltage	V <sub>SD</sub>	$T_J$ = 25 °C, I <sub>S</sub> = 2.5 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_{\rm J} = 25$ °C, $I_{\rm F} = 2.1$ A, dl/dt = 100 A/µs		-	260	520	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.7	1.4	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )			L <sub>D</sub> )		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

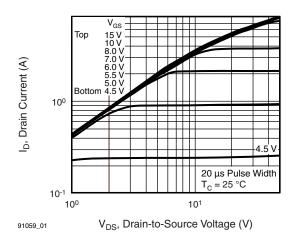


Fig. 1 - Typical Output Characteristics,  $T_C = 25 \ ^{\circ}C$ 

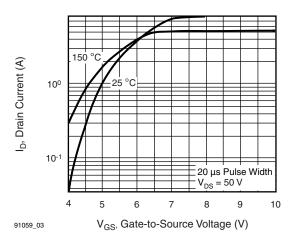


Fig. 3 - Typical Transfer Characteristics

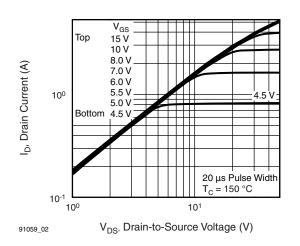


Fig. 2 - Typical Output Characteristics,  $T_C = 150$  °C

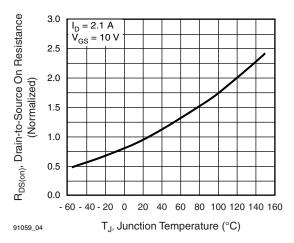


Fig. 4 - Normalized On-Resistance vs. Temperature

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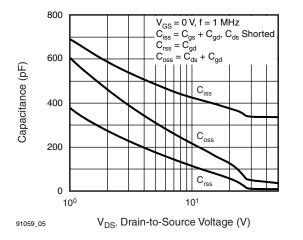


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

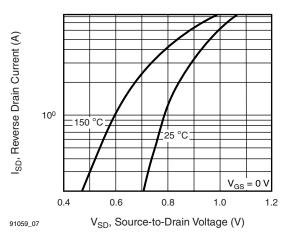


Fig. 7 - Typical Source-Drain Diode Forward Voltage

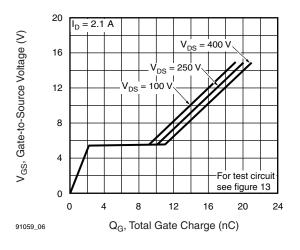


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

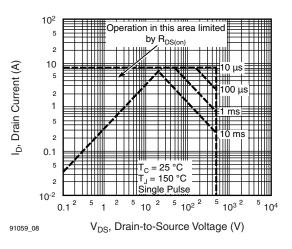


Fig. 8 - Maximum Safe Operating Area

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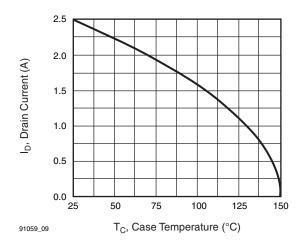


Fig. 9 - Maximum Drain Current vs. Case Temperature

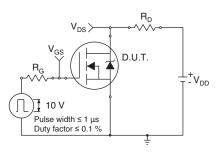


Fig. 10a - Switching Time Test Circuit

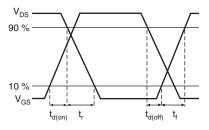
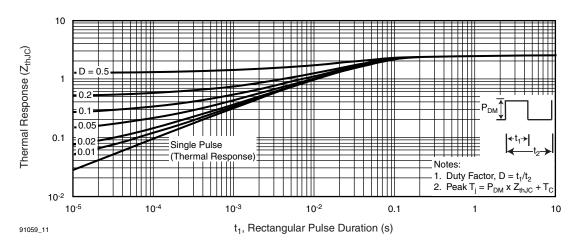


Fig. 10b - Switching Time Waveforms





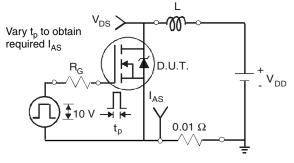


Fig. 12a - Unclamped Inductive Test Circuit

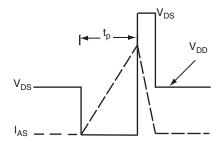
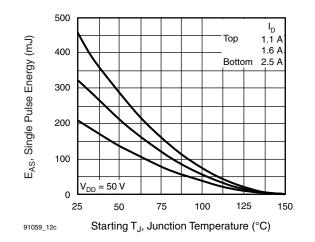


Fig. 12b - Unclamped Inductive Waveforms

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#### Fig. 12c - Maximum Avalanche Energy vs. Drain Current

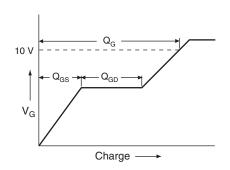


Fig. 13a - Basic Gate Charge Waveform

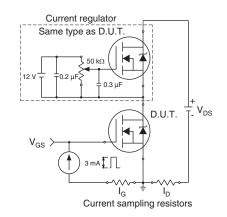
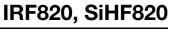


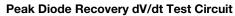
Fig. 13b - Gate Charge Test

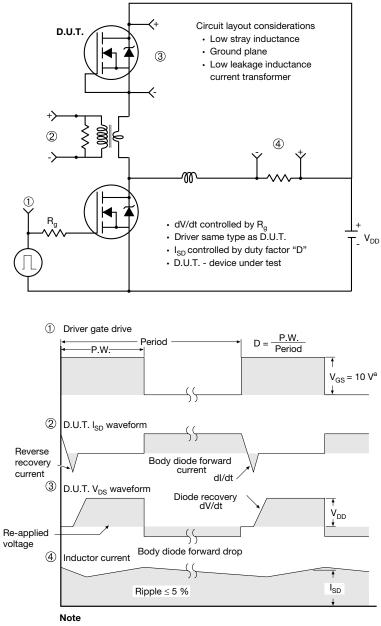
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a.  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

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## **TO-220AB**



	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
	0413-Rev. P,		0.102	0.118	

Note

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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